

## **MOSFET**

### OptiMOS<sup>™</sup> 5 Power-Transistor, 25 V

### **Features**

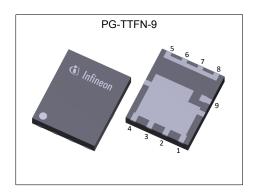
- N-channel, logic level
- Very low on-resistance R<sub>DS(on)</sub>
  Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

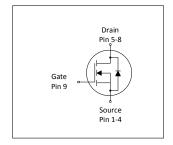
### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

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Parameter	Value	Unit					
$V_{ t DS}$	25	V					
$R_{ extsf{DS(on)}, ext{max}}$	0.29	mΩ					
I <sub>D</sub>	789	A					
Qoss	127	nC					
Q <sub>G</sub>	88	nC					











Type / Ordering Code	Package	Marking	Related Links
IQDH29NE2LM5CG	PG-TTFN-9	H29E2LC	-

# OptiMOS<sup>™</sup> 5 Power-Transistor, 25 V



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## OptiMOS<sup>™</sup> 5 Power-Transistor, 25 V IQDH29NE2LM5CG



## 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

Damanastan	Cumbal	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	- - -	789 499 454 75	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	3156	Α	<i>T</i> <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	1200	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-16	-	16	V	-
Power dissipation	P <sub>tot</sub>	-	-	278 2.5	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =50 °C/W <sup>2)</sup>
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	-

#### 2 Thermal characteristics

#### Table 3 Thermal characteristics

Baramatar	Symbol	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	0.45	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area <sup>2)</sup>	R <sub>thJA</sub>	-	-	50	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information

## OptiMOS<sup>™</sup> 5 Power-Transistor, 25 V IQDH29NE2LM5CG



### 3 Electrical characteristics

at T<sub>j</sub>=25 °C, unless otherwise specified

**Table 4** Static characteristics

Parameter	0		Value	s		
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	25	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	1.2	1.6	2.0	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =1448 μA
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μA	V <sub>DS</sub> =20 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =20 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =16 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.2 0.3	0.29 0.35	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =50 A V <sub>GS</sub> =4.5 V, I <sub>D</sub> =50 A
Gate resistance	R <sub>G</sub>	-	0.46	-	Ω	-
Transconductance	<b>g</b> fs	305	610	-	S	$ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 50 A$

Table 5 Dynamic characteristics

Parameter	Cumbal	Values			I I m i4	Note / Tost Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	13000	17000	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =12 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	5400	7000	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =12 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	380	660	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =12 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	14	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	t <sub>r</sub>	-	6	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	77	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	19	_	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	Cymahal	Values			l lmi4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	28	-	nC	$V_{\rm DD}$ =12 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	20	-	nC	$V_{DD}$ =12 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 4.5 V
Gate to drain charge <sup>1)</sup>	$Q_{gd}$	-	17	25	nC	$V_{DD}$ =12 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 4.5 V
Switching charge	Q <sub>sw</sub>	-	25	-	nC	$V_{DD}$ =12 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	88	110	nC	$V_{DD}$ =12 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 4.5 V
Gate plateau voltage	V <sub>plateau</sub>	-	2.2	-	V	$V_{\rm DD}$ =12 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total	Qg	-	191	254	nC	$V_{\rm DD}$ =12 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	84	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 4.5 V
Output charge <sup>1)</sup>	Qoss	-	127	-	nC	V <sub>DS</sub> =12 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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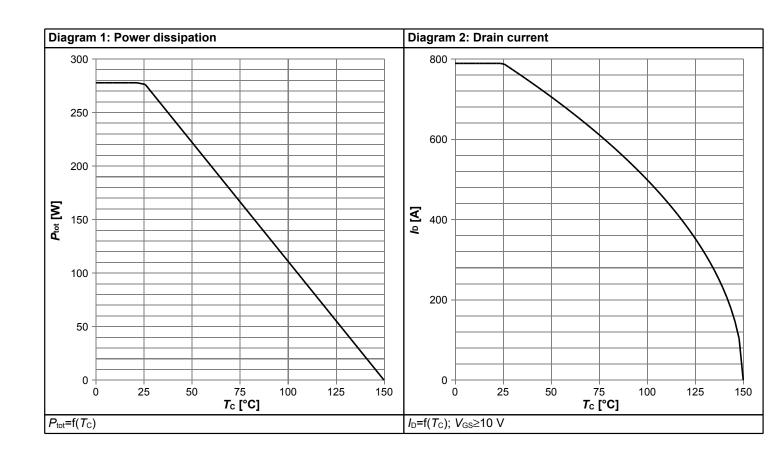


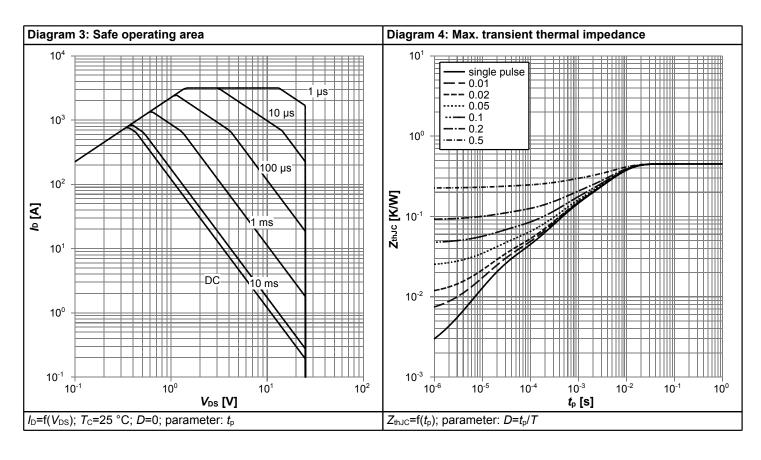
### Table 7 Reverse diode

Parameter	Complete al	Values			11	Nata / Tast Canditian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	248	Α	T <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	3156	Α	T <sub>C</sub> =25 °C
Diode forward voltage	V <sub>SD</sub>	-	0.74	1.0	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =50 A, T <sub>j</sub> =25 °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	59	118	ns	V <sub>R</sub> =12 V, I <sub>F</sub> =25 A, di <sub>F</sub> /dt=100 A/μs
Reverse recovery charge <sup>1)</sup>	Q <sub>rr</sub>	-	120	240	nC	V <sub>R</sub> =12 V, I <sub>F</sub> =25 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs

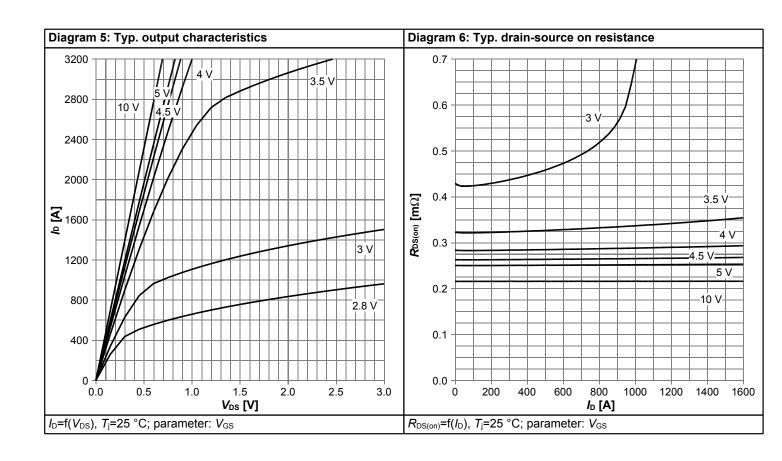


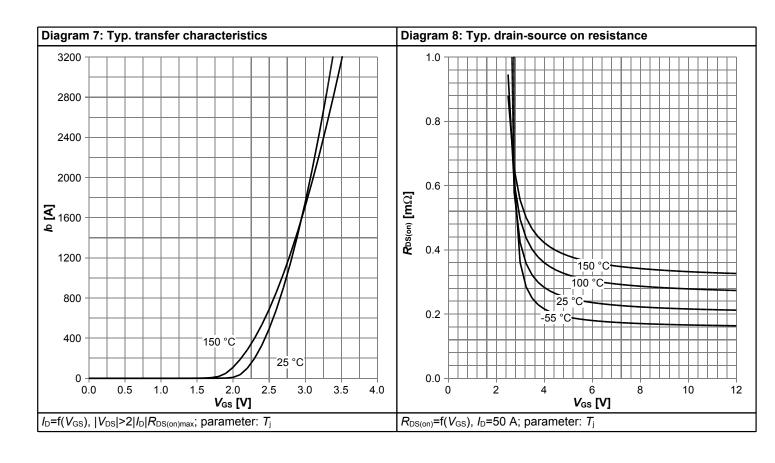
## 4 Electrical characteristics diagrams



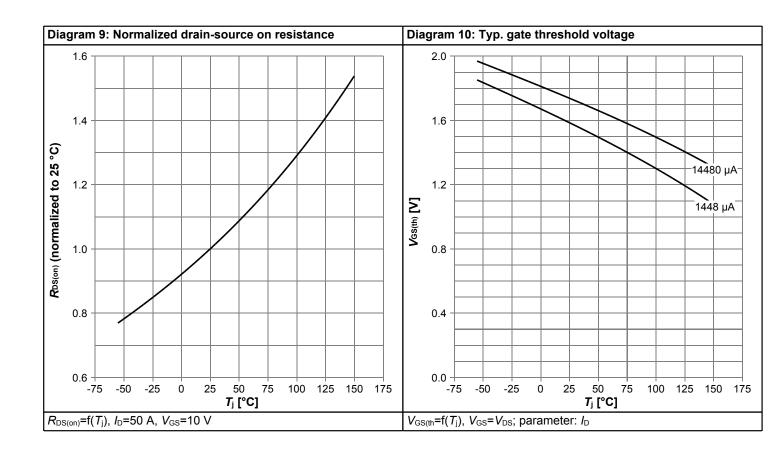


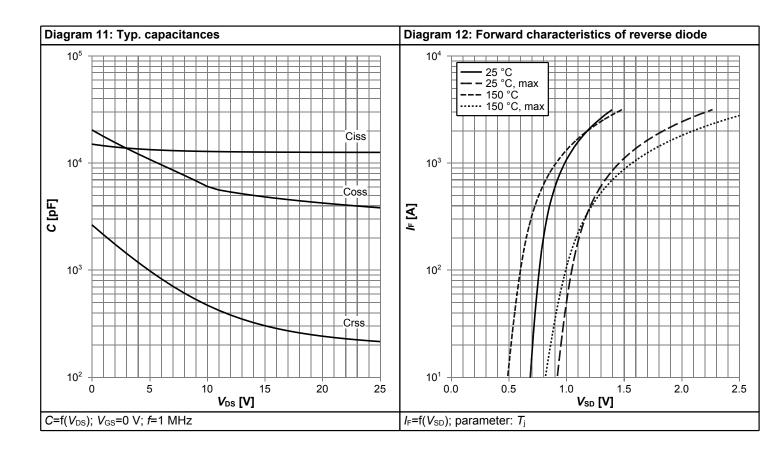




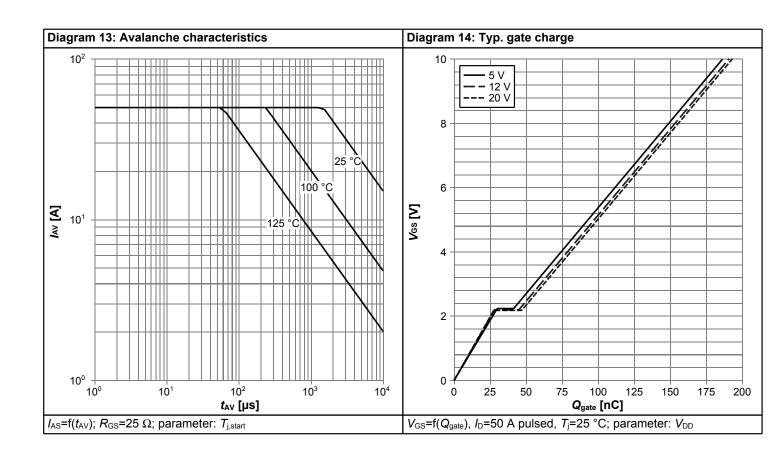


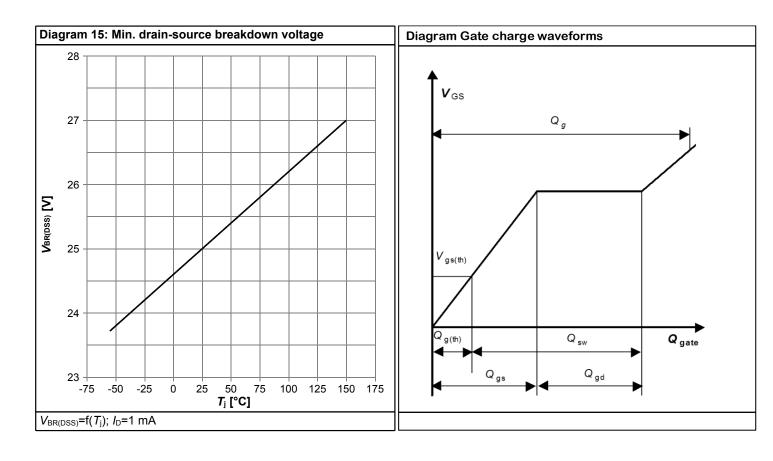














## 5 Package Outlines

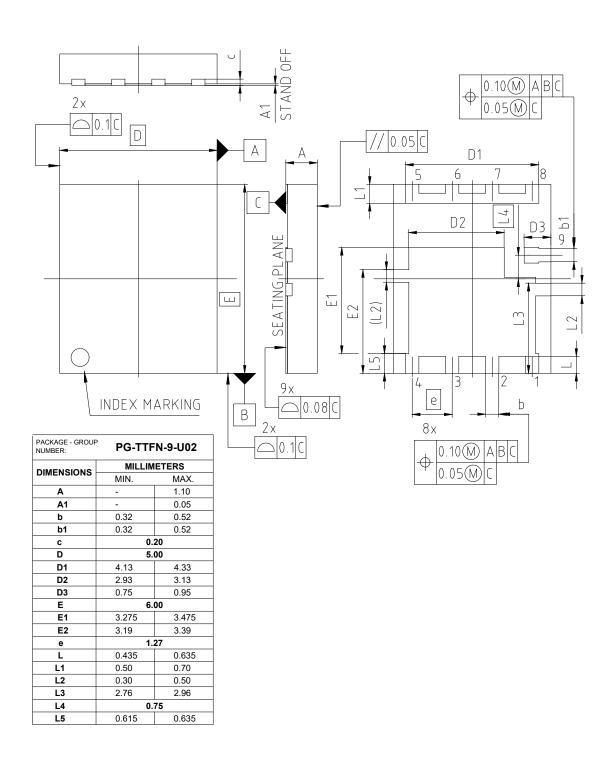


Figure 1 Outline PG-TTFN-9, dimensions in mm

## OptiMOS<sup>™</sup> 5 Power-Transistor, 25 V IQDH29NE2LM5CG



### **Revision History**

IQDH29NE2LM5CG

Revision: 2023-03-29, Rev. 2.1

Previous Revision

Trombac Novicion							
Revision	sion Date Subjects (major changes since last revision)						
2.0	2023-03-13	Release of final version					
2.1	2023-03-29	Update RG,ext switching times					

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